

# NB6L16

## 2.5V / 3.3V Multilevel Input to Differential LVPECL/LVNECL Clock or Data Receiver/Driver/Translator Buffer

The NB6L16 is a high precision, low power ECL differential clock or data receiver/driver/translator buffer. The device is functionally equivalent to the EL16, EP16, LVEL16 and NBSG16 devices. With output transition times of 70 ps, it is ideally suited for high frequency, low power systems. The device is targeted for Backplane buffering, GbE clock/data distribution, Fibre Channel distribution and SONET clock/data distribution applications.

Input accept LVNECL (Negative ECL), LVPECL (Positive ECL), LVTTTL, LVCMOS, CML, or LVDS. Outputs are 800 mV ECL signals.

The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a 0.01 mF capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

### Features

- Maximum Input Clock Frequency  $\geq 6$  GHz Typical
- Maximum Input Data Rate Frequency  $\geq 6$  Gb/s Typical
- Low 12 mA Typical Power Supply Current
- 70 ps Typical Rise/Fall Times
- 130 ps Input Propagation Delay
- On-Chip Reference for ECL Single-Ended Input –  $V_{BB}$  Output
- PECL Mode Operating Range:  
 $V_{CC} = 2.375$  V to 3.465 V with  $V_{EE} = 0$  V
- NECL Mode Operating Range:  
 $V_{CC} = 0$  V with  $V_{EE} = -2.375$  V to  $-3.465$  V
- Open Input Default State
- LVDS, LVPECL, LVNECL, LVCMOS, LVTTTL and CML Input Compatible
- Pb-Free Packages are Available



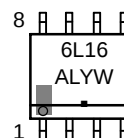
ON Semiconductor®

<http://onsemi.com>

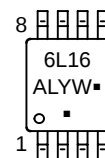
### MARKING DIAGRAMS\*



SOIC-8  
D SUFFIX  
CASE 751



TSSOP-8  
DT SUFFIX  
CASE 948R



A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

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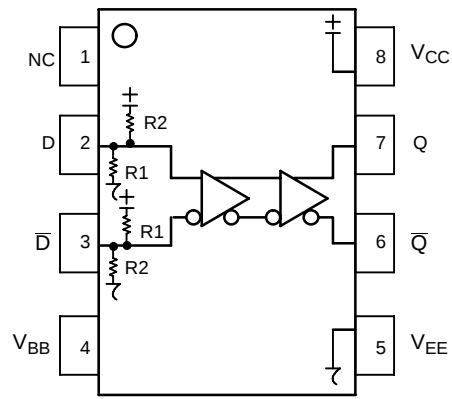


Figure 1. Pinout (Top View) and Logic Diagram

Table 1. PIN DESCRIPTION

| Pin | Name            | I/O                                             | Default State | Description                                                                                                                    |
|-----|-----------------|-------------------------------------------------|---------------|--------------------------------------------------------------------------------------------------------------------------------|
| 1   | NC              | –                                               | –             | No Connect. The NC pin is electrically connected to the die and MUST be left open.                                             |
| 2   | D               | LVDS, CML, LVPECL, LVNECL, LVTTTL, LVCMOS Input | LOW           | Non-inverted differential clock/data input. Internal 75 k $\Omega$ to V <sub>CC</sub> and 37.5 k $\Omega$ to V <sub>EE</sub> . |
| 3   | $\bar{D}$       | LVDS, CML, LVPECL, LVNECL, LVTTTL, LVCMOS Input | HIGH          | Inverted differential clock/data input. Internal 37.5 k $\Omega$ to V <sub>CC</sub> and 75 k $\Omega$ to V <sub>EE</sub> .     |
| 4   | V <sub>BB</sub> | –                                               | –             | Internally generated ECL reference voltage supply.                                                                             |
| 5   | V <sub>EE</sub> | –                                               | –             | Negative power supply voltage.                                                                                                 |
| 6   | $\bar{Q}$       | ECL Output                                      |               | Inverted differential ECL output. Typically terminated with 50 $\Omega$ resistor to V <sub>CC</sub> – 2.0 V.                   |
| 7   | Q               | ECL Output                                      |               | Non-inverted differential ECL output. Typically terminated with 50 $\Omega$ resistor to V <sub>CC</sub> – 2.0 V.               |
| 8   | V <sub>CC</sub> | –                                               | –             | Positive power supply voltage.                                                                                                 |

Table 2. ATTRIBUTES

| Characteristics                                               | Value                                                     |
|---------------------------------------------------------------|-----------------------------------------------------------|
| Internal Input Default State Resistor (R1)                    | 37.5 k $\Omega$                                           |
| Internal Input Default State Resistor (R2)                    | 75 k $\Omega$                                             |
| ESD Protection                                                | Human Body Model<br>Machine Model<br>Charged Device Model |
|                                                               | > 2 kV<br>> 100 V<br>> 1 kV                               |
| Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1) | Level 1                                                   |
| Flammability Rating                                           | Oxygen Index: 28 to 34                                    |
|                                                               | UL 94 V-0 @ 1.125 in                                      |
| Transistor Count                                              | 167                                                       |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test        |                                                           |

1. For additional information, see Application Note AND8003/D.

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**Table 3. MAXIMUM RATINGS**

| Symbol        | Parameter                                  | Condition 1                                                             | Condition 2       | Rating                                  | Units |
|---------------|--------------------------------------------|-------------------------------------------------------------------------|-------------------|-----------------------------------------|-------|
| $V_{CC}$      | PECL Mode Power Supply                     | $V_{EE} = 0\text{ V}$                                                   |                   | 3.6                                     | V     |
| $V_{EE}$      | NECL Mode Power Supply                     | $V_{CC} = 0\text{ V}$                                                   |                   | -3.6                                    | V     |
| $V_I$         | PECL Mode Input Voltage                    | $V_{EE} = 0\text{ V}$                                                   | $V_I \leq V_{CC}$ | 3.6                                     | V     |
|               | NECL Mode Input Voltage                    | $V_{CC} = 0\text{ V}$                                                   | $V_I \geq V_{EE}$ | -3.6                                    | V     |
| $I_{out}$     | Output Current                             | Continuous<br>Surge                                                     |                   | 25                                      | mA    |
|               |                                            |                                                                         |                   | 50                                      | mA    |
| $V_{INPP}$    | Differential Input Voltage $ D - \bar{D} $ | $V_{CC} - V_{EE} \geq 2.8\text{ V}$<br>$V_{CC} - V_{EE} < 2.8\text{ V}$ |                   | 2.8<br>$ V_{CC} - V_{EE} $              | V     |
| $I_{BB}$      | $V_{BB}$ Sink/Source                       |                                                                         |                   | $\pm 0.5$                               | mA    |
| $T_A$         | Operating Temperature Range                |                                                                         |                   | -40 to +85                              | °C    |
| $T_{stg}$     | Storage Temperature Range                  |                                                                         |                   | -65 to +150                             | °C    |
| $\theta_{JA}$ | Thermal Resistance (Junction-to-Ambient)   | 0 lfpm                                                                  | SOIC-8            | 190                                     | °C/W  |
|               |                                            | 500 lfpm                                                                | SOIC-8            | 130                                     | °C/W  |
| $\theta_{JC}$ | Thermal Resistance (Junction-to-Case)      | Standard Board                                                          | SOIC-8            | 41 to 44                                | °C/W  |
| $\theta_{JA}$ | Thermal Resistance (Junction-to-Ambient)   | 0 lfpm                                                                  | TSSOP-8           | 185                                     | °C/W  |
|               |                                            | 500 lfpm                                                                | TSSOP-8           | 140                                     | °C/W  |
| $\theta_{JC}$ | Thermal Resistance (Junction-to-Case)      | Standard Board                                                          | TSSOP-8           | 41 to 44                                | °C/W  |
| $T_{sol}$     | Wave Solder                                | Standard<br>Pb-Free                                                     |                   | $\leq 3\text{ sec @ }248^\circ\text{C}$ | °C    |
|               |                                            |                                                                         |                   | $\leq 3\text{ sec @ }260^\circ\text{C}$ |       |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

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**Table 4. DC CHARACTERISTICS, PECL**  $V_{CC} = 2.5\text{ V}$ ,  $V_{EE} = 0\text{ V}$  (Note 4)

| Symbol   | Characteristic                         | -40°C |      |      | 25°C |      |      | 85°C |      |      | Unit |
|----------|----------------------------------------|-------|------|------|------|------|------|------|------|------|------|
|          |                                        | Min   | Typ  | Max  | Min  | Typ  | Max  | Min  | Typ  | Max  |      |
| $I_{EE}$ | Negative Power Supply Current (Note 5) | 10    | 12   | 18   | 10   | 12   | 18   | 10   | 12   | 18   | mA   |
| $V_{OH}$ | Output HIGH Voltage (Note 6)           | 1350  | 1450 | 1550 | 1400 | 1500 | 1600 | 1450 | 1550 | 1650 | mV   |
| $V_{OL}$ | Output LOW Voltage (Note 6)            | 565   | 725  | 870  | 630  | 765  | 920  | 690  | 825  | 970  | mV   |

**DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED** (Figures 10, 12)

|          |                                                      |               |  |               |               |  |               |               |  |               |    |
|----------|------------------------------------------------------|---------------|--|---------------|---------------|--|---------------|---------------|--|---------------|----|
| $V_{th}$ | Input Threshold Reference Voltage Range (Notes 2, 7) | 1125          |  | $V_{CC} - 75$ | 1125          |  | $V_{CC} - 75$ | 1125          |  | $V_{CC} - 75$ | mV |
| $V_{IH}$ | Single-Ended Input HIGH Voltage                      | $V_{th} + 75$ |  | $V_{CC}$      | $V_{th} + 75$ |  | $V_{CC}$      | $V_{th} + 75$ |  | $V_{CC}$      | mV |
| $V_{IL}$ | Single-Ended Input LOW Voltage                       | $V_{EE}$      |  | $V_{th} - 75$ | $V_{EE}$      |  | $V_{th} - 75$ | $V_{EE}$      |  | $V_{th} - 75$ | mV |

**DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY** (Figures 11, 13)

|           |                                                                     |          |              |               |          |              |               |          |              |               |    |
|-----------|---------------------------------------------------------------------|----------|--------------|---------------|----------|--------------|---------------|----------|--------------|---------------|----|
| $V_{IHD}$ | Differential Input HIGH Voltage                                     | 1200     |              | $V_{CC}$      | 1200     |              | $V_{CC}$      | 1200     |              | $V_{CC}$      | mV |
| $V_{ILD}$ | Differential Input LOW Voltage                                      | $V_{EE}$ |              | $V_{CC} - 75$ | $V_{EE}$ |              | $V_{CC} - 75$ | $V_{EE}$ |              | $V_{CC} - 75$ | mV |
| $V_{CMR}$ | Input Common Mode Range (Differential Cross-Point Voltage) (Note 3) | 1163     |              | $V_{CC} - 38$ | 1163     |              | $V_{CC} - 38$ | 1163     |              | $V_{CC} - 38$ | mV |
| $V_{ID}$  | Differential Input Voltage ( $V_{IHD} - V_{ILD}$ )                  | 75       |              | 2500          | 75       |              | 2500          | 75       |              | 2500          | mV |
| $I_{IH}$  | Input HIGH Current                                                  | D<br>D   | 50<br>10     | 150<br>150    |          | 50<br>10     | 150<br>150    |          | 50<br>10     | 150<br>150    | μA |
| $I_{IL}$  | Input LOW Current                                                   | D<br>D   | -150<br>-150 | -5<br>-30     |          | -150<br>-150 | -5<br>-30     |          | -150<br>-150 | -5<br>-30     | μA |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- $V_{th}$  is applied to the complementary input when operating in single-ended mode.
- $V_{CMR}$  minimum varies 1:1 with  $V_{EE}$ ,  $V_{CMR}$  maximum varies 1:1 with  $V_{CC}$ .
- Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.125 V to -1.3 V.
- All input and output pins left open.
- All loading with 50 Ω to  $V_{CC} - 2.0\text{ V}$ .
- Do not use  $V_{BB}$  as a reference voltage for single-ended PECL signals when operating device at  $V_{CC} - V_{EE} < 3.0\text{ V}$ .

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**Table 5. DC CHARACTERISTICS, PECL**  $V_{CC} = 3.3\text{ V}$ ,  $V_{EE} = 0\text{ V}$  (Note 10)

| Symbol   | Characteristic                          | -40°C |      |      | 25°C |      |      | 85°C |      |      | Unit |
|----------|-----------------------------------------|-------|------|------|------|------|------|------|------|------|------|
|          |                                         | Min   | Typ  | Max  | Min  | Typ  | Max  | Min  | Typ  | Max  |      |
| $I_{EE}$ | Negative Power Supply Current (Note 11) | 10    | 12   | 18   | 10   | 12   | 18   | 10   | 12   | 18   | mA   |
| $V_{OH}$ | Output HIGH Voltage (Note 12)           | 2150  | 2250 | 2350 | 2200 | 2300 | 2400 | 2250 | 2350 | 2450 | mV   |
| $V_{OL}$ | Output LOW Voltage (Note 12)            | 1365  | 1525 | 1670 | 1430 | 1565 | 1720 | 1490 | 1625 | 1770 | mV   |

**DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED** (Figures 10, 12)

|          |                                                  |               |      |               |               |      |               |               |      |               |    |
|----------|--------------------------------------------------|---------------|------|---------------|---------------|------|---------------|---------------|------|---------------|----|
| $V_{th}$ | Input Threshold Reference Voltage Range (Note 8) | 1125          |      | $V_{CC} - 75$ | 1125          |      | $V_{CC} - 75$ | 1125          |      | $V_{CC} - 75$ | mV |
| $V_{IH}$ | Single-Ended Input HIGH Voltage                  | $V_{th} + 75$ |      | $V_{CC}$      | $V_{th} + 75$ |      | $V_{CC}$      | $V_{th} + 75$ |      | $V_{CC}$      | mV |
| $V_{IL}$ | Single-Ended Input LOW Voltage                   | $V_{EE}$      |      | $V_{th} - 75$ | $V_{EE}$      |      | $V_{th} - 75$ | $V_{EE}$      |      | $V_{th} - 75$ | mV |
| $V_{BB}$ | Output Voltage Reference                         | 1880          | 1980 | 2070          | 1880          | 1980 | 2070          | 1880          | 1980 | 2070          | mV |

**DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY** (Figures 11, 13)

|           |                                                                     |          |              |               |          |              |               |          |              |               |    |
|-----------|---------------------------------------------------------------------|----------|--------------|---------------|----------|--------------|---------------|----------|--------------|---------------|----|
| $V_{IHD}$ | Differential Input HIGH Voltage                                     | 1200     |              | $V_{CC}$      | 1200     |              | $V_{CC}$      | 1200     |              | $V_{CC}$      | mV |
| $V_{ILD}$ | Differential Input LOW Voltage                                      | $V_{EE}$ |              | $V_{CC} - 75$ | $V_{EE}$ |              | $V_{CC} - 75$ | $V_{EE}$ |              | $V_{CC} - 75$ | mV |
| $V_{CMR}$ | Input Common Mode Range (Differential Cross-Point Voltage) (Note 9) | 1163     |              | $V_{CC} - 38$ | 1163     |              | $V_{CC} - 38$ | 1163     |              | $V_{CC} - 38$ | mV |
| $V_{ID}$  | Differential Input Voltage ( $V_{IHD} - V_{ILD}$ )                  | 75       |              | 2500          | 75       |              | 2500          | 75       |              | 2500          | mV |
| $I_{IH}$  | Input HIGH Current                                                  | D<br>D   | 50<br>10     | 150<br>150    |          | 50<br>10     | 150<br>150    |          | 50<br>10     | 150<br>150    | μA |
| $I_{IL}$  | Input LOW Current                                                   | D<br>D   | -150<br>-150 | -5<br>-30     |          | -150<br>-150 | -5<br>-30     |          | -150<br>-150 | -5<br>-30     | μA |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

8.  $V_{th}$  is applied to the complementary input when operating in single-ended mode.

9.  $V_{CMR}$  minimum varies 1:1 with  $V_{EE}$ ,  $V_{CMR}$  maximum varies 1:1 with  $V_{CC}$ .

10. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.925 V to -0.5 V.

11. All input and output pins left open.

12. All loading with 50 Ω to  $V_{CC} - 2.0\text{ V}$ .

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**Table 6. DC CHARACTERISTICS, NECL**  $V_{CC} = 0\text{ V}$ ,  $V_{EE} = -3.465\text{ V}$  to  $-2.375\text{ V}$  (Note 15)

| Symbol   | Characteristic                          | -40°C |       |       | 25°C  |       |       | 85°C  |       |       | Unit |
|----------|-----------------------------------------|-------|-------|-------|-------|-------|-------|-------|-------|-------|------|
|          |                                         | Min   | Typ   | Max   | Min   | Typ   | Max   | Min   | Typ   | Max   |      |
| $I_{EE}$ | Negative Power Supply Current (Note 17) | 10    | 12    | 18    | 10    | 12    | 18    | 10    | 12    | 18    | mA   |
| $V_{OH}$ | Output HIGH Voltage (Note 16)           | -1150 | -1050 | -950  | -1100 | -1000 | -900  | -1050 | -950  | -850  | mV   |
| $V_{OL}$ | Output LOW Voltage (Note 16)            | -1935 | -1775 | -1630 | -1870 | -1735 | -1580 | -1810 | -1675 | -1530 | mV   |

**DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED** (Figures 10, 12)

|          |                                                  |                 |       |               |                 |       |               |                 |       |               |    |
|----------|--------------------------------------------------|-----------------|-------|---------------|-----------------|-------|---------------|-----------------|-------|---------------|----|
| $V_{th}$ | Input Threshold Reference Voltage Range (Note 8) | $V_{EE} + 1125$ |       | $V_{CC} - 75$ | $V_{EE} + 1125$ |       | $V_{CC} - 75$ | $V_{EE} + 1125$ |       | $V_{CC} - 75$ | mV |
| $V_{IH}$ | Single-Ended Input HIGH Voltage                  | $V_{th} + 75$   |       | $V_{CC}$      | $V_{th} + 75$   |       | $V_{CC}$      | $V_{th} + 75$   |       | $V_{CC}$      | mV |
| $V_{IL}$ | Single-Ended Input LOW Voltage                   | $V_{EE}$        |       | $V_{th} - 75$ | $V_{EE}$        |       | $V_{th} - 75$ | $V_{EE}$        |       | $V_{th} - 75$ | mV |
| $V_{BB}$ | Output Voltage Reference                         | -1420           | -1320 | -1230         | -1420           | -1320 | -1230         | -1420           | -1320 | -1230         | mV |

**DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY** (Figures 11, 13)

|           |                                                                     |                 |           |               |                 |           |               |                 |           |               |               |
|-----------|---------------------------------------------------------------------|-----------------|-----------|---------------|-----------------|-----------|---------------|-----------------|-----------|---------------|---------------|
| $V_{IHD}$ | Differential Input HIGH Voltage                                     | $V_{EE} + 1200$ |           | $V_{CC}$      | $V_{EE} + 1200$ |           | $V_{CC}$      | $V_{EE} + 1200$ |           | $V_{CC}$      | mV            |
| $V_{ILD}$ | Differential Input LOW Voltage                                      | $V_{EE}$        |           | $V_{CC} - 75$ | $V_{EE}$        |           | $V_{CC} - 75$ | $V_{EE}$        |           | $V_{CC} - 75$ | mV            |
| $V_{CMR}$ | Input Common Mode Range (Differential Cross-Point Voltage) (Note 9) | $V_{EE} + 1163$ |           | $V_{CC} - 38$ | $V_{EE} + 1163$ |           | $V_{CC} - 38$ | $V_{EE} + 1163$ |           | $V_{CC} - 38$ | mV            |
| $V_{ID}$  | Differential Input Voltage ( $V_{IHD} - V_{ILD}$ )                  | 75              |           | 2500          | 75              |           | 2500          | 75              |           | 2500          | mV            |
| $I_{IH}$  | Input HIGH Current $\frac{D}{D}$                                    |                 | 50<br>10  | 150<br>150    |                 | 50<br>10  | 150<br>150    |                 | 50<br>10  | 150<br>150    | $\mu\text{A}$ |
| $I_{IL}$  | Input LOW Current $\frac{D}{D}$                                     | -150<br>-150    | -5<br>-30 |               | -150<br>-150    | -5<br>-30 |               | -150<br>-150    | -5<br>-30 |               | $\mu\text{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

13.  $V_{th}$  is applied to the complementary input when operating in single-ended mode.

14.  $V_{CMR}$  minimum varies 1:1 with  $V_{EE}$ ,  $V_{CMR}$  maximum varies 1:1 with  $V_{CC}$ .

15. Input and output parameters vary 1:1 with  $V_{CC}$ .

16. All loading with  $50\ \Omega$  to  $V_{CC} - 2.0\text{ V}$ .

17. All input and output pins left open.

**Table 7. AC CHARACTERISTICS**  $V_{CC} = 0\text{ V}$ ;  $V_{EE} = -3.465\text{ V}$  to  $-2.375\text{ V}$  or  $V_{CC} = 2.375\text{ V}$  to  $3.465\text{ V}$ ;  $V_{EE} = 0\text{ V}$  (Note 18)

| Symbol                   | Characteristic                                                                                                                           | -40°C      |            |          | 25°C       |            |          | 85°C       |            |          | Unit |
|--------------------------|------------------------------------------------------------------------------------------------------------------------------------------|------------|------------|----------|------------|------------|----------|------------|------------|----------|------|
|                          |                                                                                                                                          | Min        | Typ        | Max      | Min        | Typ        | Max      | Min        | Typ        | Max      |      |
| $V_{OUTPP}$              | Output Voltage Amplitude<br>(See Figures 2 & 3)<br>$f_{in} < 3\text{ GHz}$<br>$f_{in} < 6\text{ GHz}$                                    | 500<br>270 | 700<br>350 |          | 500<br>270 | 700<br>350 |          | 500<br>270 | 700<br>300 |          | mV   |
| $t_{PLH}$ ,<br>$t_{PHL}$ | Propagation Delay to<br>Output Differential @ 1 GHz                                                                                      | 80         | 130        | 180      | 80         | 130        | 180      | 85         | 135        | 185      | ps   |
| $t_{SKEW}$               | Duty Cycle Skew (Note 19)<br>Device-to-Device Skew                                                                                       |            | 3<br>30    | 25<br>60 |            | 3<br>30    | 25<br>60 |            | 3<br>30    | 25<br>60 | ps   |
| $t_{JITTER}$             | RMS Random Clock Jitter<br>(Note 20) $f_{in} < 6\text{ GHz}$<br>Peak-to-Peak Data Dependent Jitter<br>(Note 21) $f_{in} < 6\text{ Gb/s}$ |            | 0.2<br>2   | 1<br>12  |            | 0.2<br>2   | 1<br>12  |            | 0.2<br>2   | 1<br>12  | ps   |
| $V_{INPP}$               | Input Voltage Swing / Sensitivity<br>(Differential Configuration) (Note 22)                                                              | 75         | 700        | 2500     | 75         | 700        | 2500     | 75         | 700        | 2500     | mV   |
| $t_r$<br>$t_f$           | Output Rise/Fall Times $Q, \bar{Q}$<br>(20% – 80%)                                                                                       | 30         | 70         | 120      | 30         | 70         | 120      | 30         | 70         | 120      | ps   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

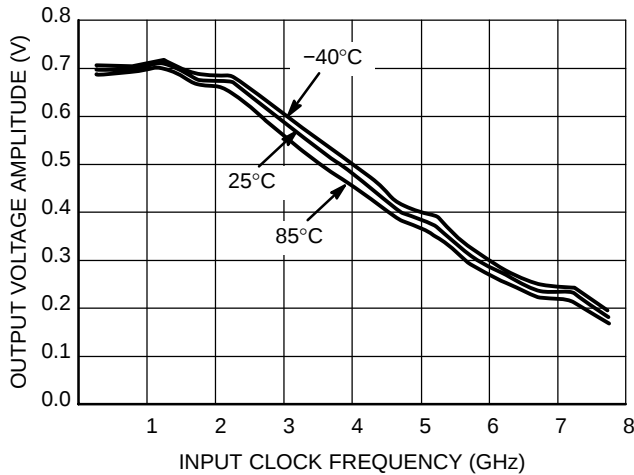
18. Measured using a 800 mV source, 50% duty cycle clock source. All loading with  $50\ \Omega$  to  $V_{CC}$ . Input edge rates 40 ps (20% – 80%).

19. See Figure 9  $t_{skew} = |t_{PLH} - t_{PHL}|$  for a nominal 50% differential clock input waveform. Skew is measured between outputs under identical transitions and conditions @ 1 GHz.

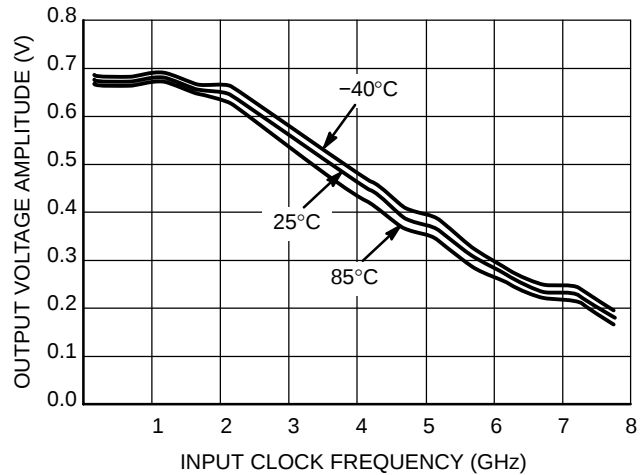
20. Additive RMS jitter with 50% duty cycle clock signal at 6 GHz.

21. Additive Peak-to-Peak data dependent jitter with NRZ PRBS 2<sup>23</sup>-1 data rate at 6 Gb/s.

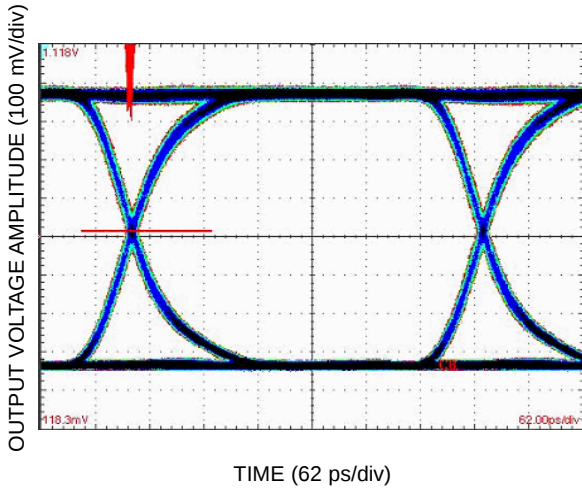
22.  $V_{INPP(max)}$  cannot exceed  $V_{CC} - V_{EE}$ . (Applicable only when  $V_{CC} - V_{EE} < 2500\text{ mV}$ ). Input voltage swing is a single-ended measurement operating in the differential mode.



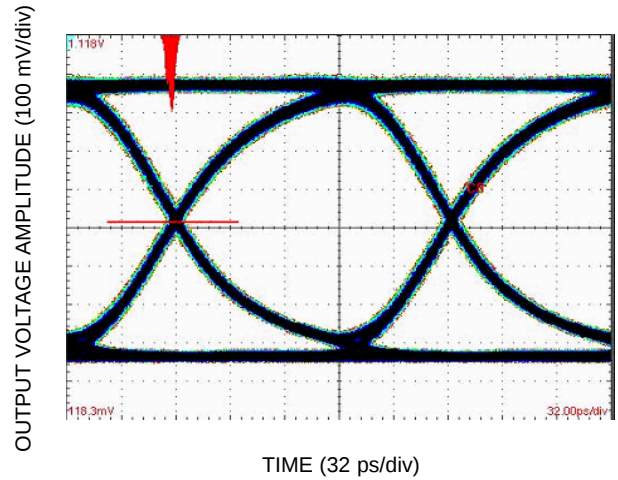
**Figure 2. Output Voltage Amplitude ( $V_{OUTPP}$ ) versus Input Clock Frequency ( $f_{IN}$ ) and Temperature at  $V_{CC} - V_{EE} = 3.3\text{ V}$**



**Figure 3. Output Voltage Amplitude ( $V_{OUTPP}$ ) versus Input Clock Frequency ( $f_{IN}$ ) and Temperature at  $V_{CC} - V_{EE} = 2.5\text{ V}$**

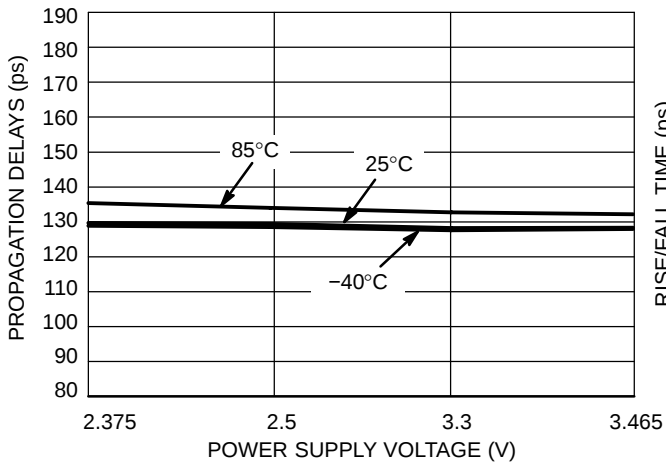


**Figure 4. Typical Output Waveform at 2.488 Gb/s with PRBS 2<sup>23</sup>-1 (Total System Pk-Pk Jitter is 16 ps. Device Pk-Pk Jitter Contribution is 3 ps)**

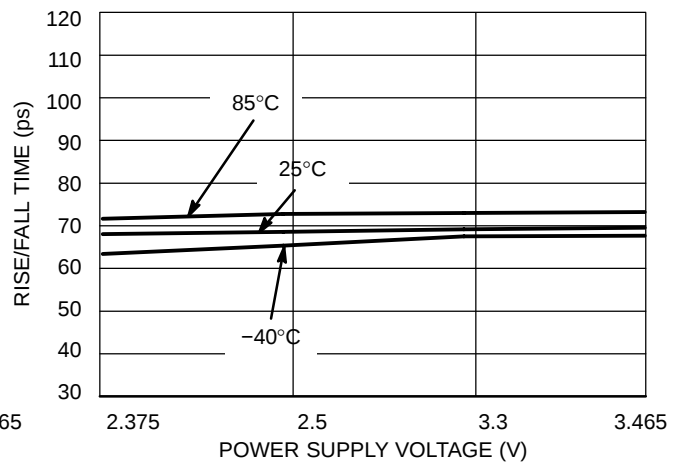


**Figure 5. Typical Output Waveform at 6.125 Gb/s with PRBS 2<sup>23</sup>-1 (Total System Pk-Pk Jitter is 17 ps. Device Pk-Pk Jitter Contribution is 4 ps)**

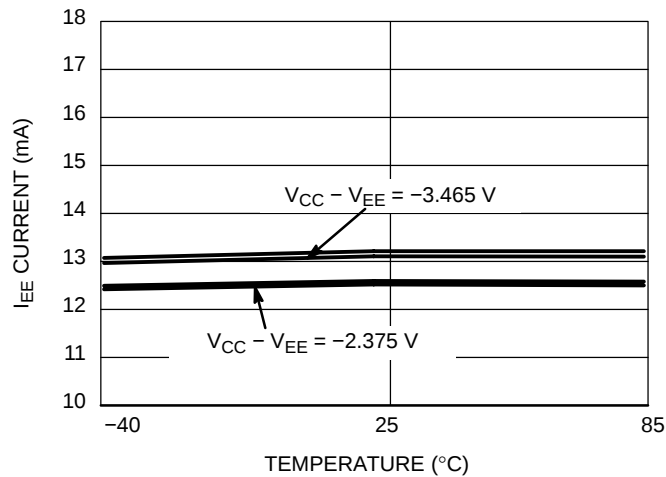
NOTE:  $V_{CC} - V_{EE} = 3.3 \text{ V}$ ;  $V_{IN} = 700 \text{ mV}$ ;  $T_A = 25^\circ\text{C}$ .



**Figure 6. Propagation Delay versus Power Supply Voltage and Temperature**



**Figure 7. Rise/Fall Time versus Power Supply Voltage and Temperature**



**Figure 8.  $I_{EE}$  Current versus Temperature and Power Supply Voltage**

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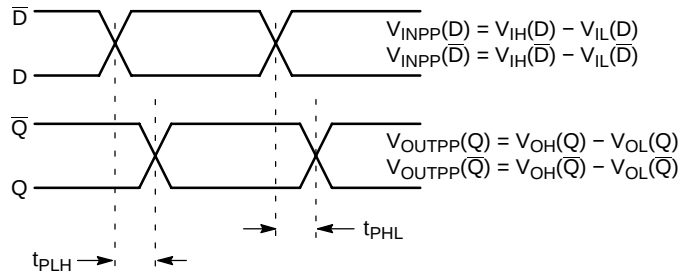


Figure 9. AC Reference Measurement

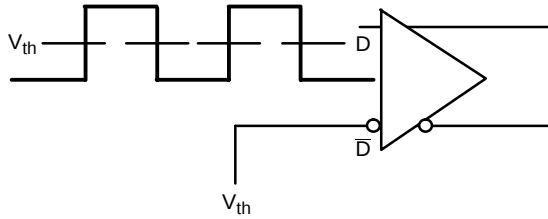


Figure 10. Differential Input Driven Single-Ended

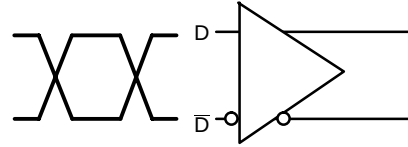


Figure 11. Differential Inputs Driven Differentially

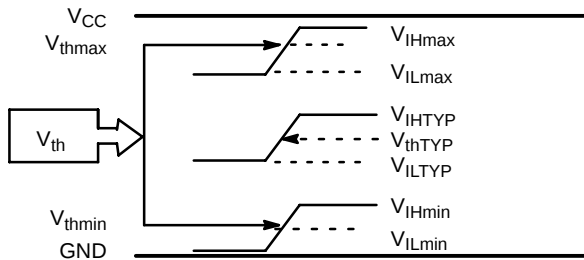


Figure 12.  $V_{th}$  Diagram

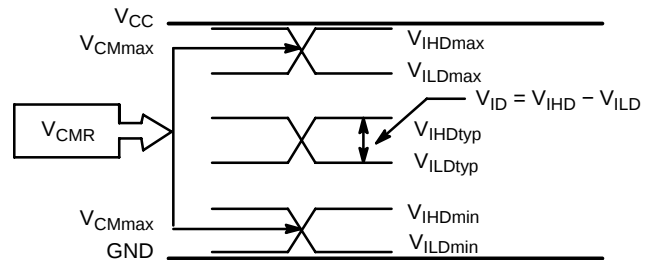


Figure 13.  $V_{CMR}$  Diagram

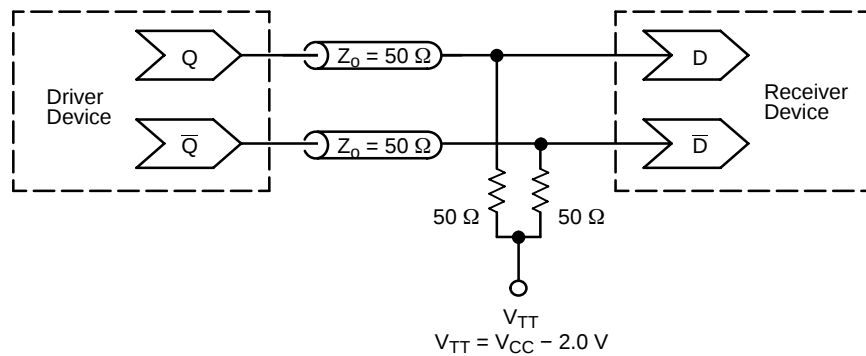


Figure 14. Typical Termination for Output Driver and Device Evaluation  
(See Application Note AND8020/D – Termination of ECL Logic Devices.)

## NB6L16

### ORDERING INFORMATION

| Device      | Package              | Shipping <sup>†</sup> |
|-------------|----------------------|-----------------------|
| NB6L16D     | SOIC-8               | 98 Units / Rail       |
| NB6L16DG    | SOIC-8<br>(Pb-Free)  | 98 Units / Rail       |
| NB6L16DR2   | SOIC-8               | 2500 / Tape & Reel    |
| NB6L16DR2G  | SOIC-8<br>(Pb-Free)  | 2500 / Tape & Reel    |
| NB6L16DT    | TSSOP-8              | 100 Units / Rail      |
| NB6L16DTG   | TSSOP-8<br>(Pb-Free) | 100 Units / Rail      |
| NB6L16DTR2  | TSSOP-8              | 2500 / Tape & Reel    |
| NB6L16DTR2G | TSSOP-8<br>(Pb-Free) | 2500 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

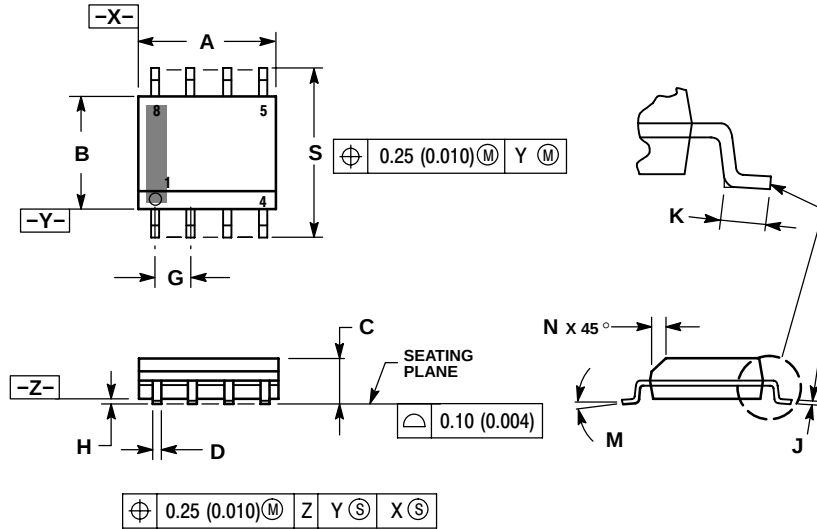
### Resource Reference of Application Notes

- AN1405/D** – ECL Clock Distribution Techniques
- AN1406/D** – Designing with PECL (ECL at +5.0 V)
- AN1503/D** – ECLinPS™ I/O SPICE Modeling Kit
- AN1504/D** – Metastability and the ECLinPS Family
- AN1568/D** – Interfacing Between LVDS and ECL
- AN1672/D** – The ECL Translator Guide
- AND8001/D** – Odd Number Counters Design
- AND8002/D** – Marking and Date Codes
- AND8020/D** – Termination of ECL Logic Devices
- AND8066/D** – Interfacing with ECLinPS
- AND8090/D** – AC Characteristics of ECL Devices

# NB6L16

## PACKAGE DIMENSIONS

SOIC-8 NB  
CASE 751-07  
ISSUE AH

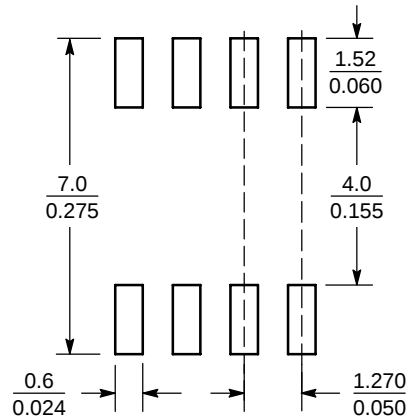


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.80        | 5.00 | 0.189     | 0.197 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.053     | 0.069 |
| D   | 0.33        | 0.51 | 0.013     | 0.020 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| H   | 0.10        | 0.25 | 0.004     | 0.010 |
| J   | 0.19        | 0.25 | 0.007     | 0.010 |
| K   | 0.40        | 1.27 | 0.016     | 0.050 |
| M   | 0°          | 8°   | 0°        | 8°    |
| N   | 0.25        | 0.50 | 0.010     | 0.020 |
| S   | 5.80        | 6.20 | 0.228     | 0.244 |

## SOLDERING FOOTPRINT\*



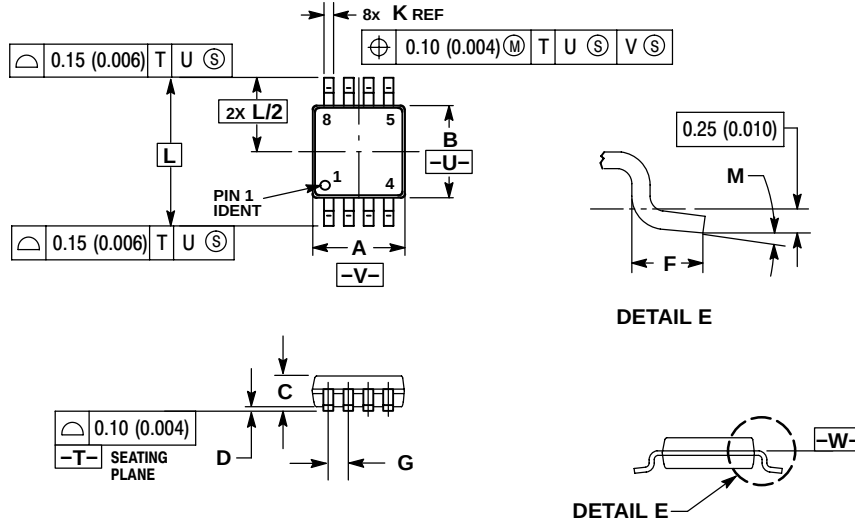
SCALE 6:1 (mm/inches)

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NB6L16

## PACKAGE DIMENSIONS

### TSSOP-8 DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948R-02 ISSUE A



#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 2.90        | 3.10 | 0.114     | 0.122 |
| B   | 2.90        | 3.10 | 0.114     | 0.122 |
| C   | 0.80        | 1.10 | 0.031     | 0.043 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.40        | 0.70 | 0.016     | 0.028 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| K   | 0.25        | 0.40 | 0.010     | 0.016 |
| L   | 4.90 BSC    |      | 0.193 BSC |       |
| M   | 0°          | 6°   | 0°        | 6°    |

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